



8-bit All Flash **78K0 Microcontrollers 78K0S Microcontrollers**





Shifting to "All Flash"

Pash

All of our 8-bit general-purpose microcontrollers employ reliable flash memories.

A new evolution leading to system development success

Answering ever more specific needs, contributing to cost cutting, delivering peace of mind that can be relied on. To ensure that our diversified offering of 8-bit microcontrollers designed for many different applications truly empower our customers,

which path should we aim for?

NEC Electronics, which has consistently been tracing the future course of microcontrollers, has come up with an answer, embodied by its shift to All Flash:

To offer a full lineup consisting entirely of flash memory products.

A truly diversified lineup that offers a full range of products, which are available with 10 to 100 pins and ROM capacity of 1 KB to 128 KB; cuts total cost by allowing program changes, the incorporation of peripheral functions, and lower power consumption; as well as providing a full range of development tools that dramatically enhance ease of use.

More than just providing its devices with sophisticated functions, NEC Electronics has also created an entire infrastructure that ranges from the development of flash microcontrollers to their delivery.

Application examples

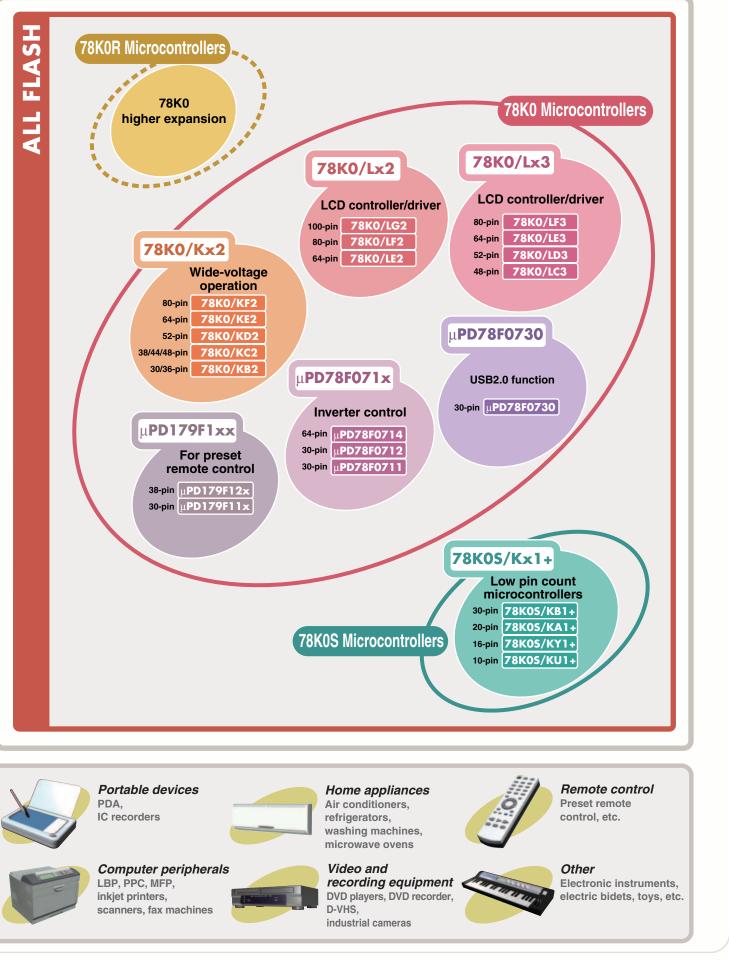
All Flash microcontrollers are suitable for various application fields and raise the commercial value of customer systems.

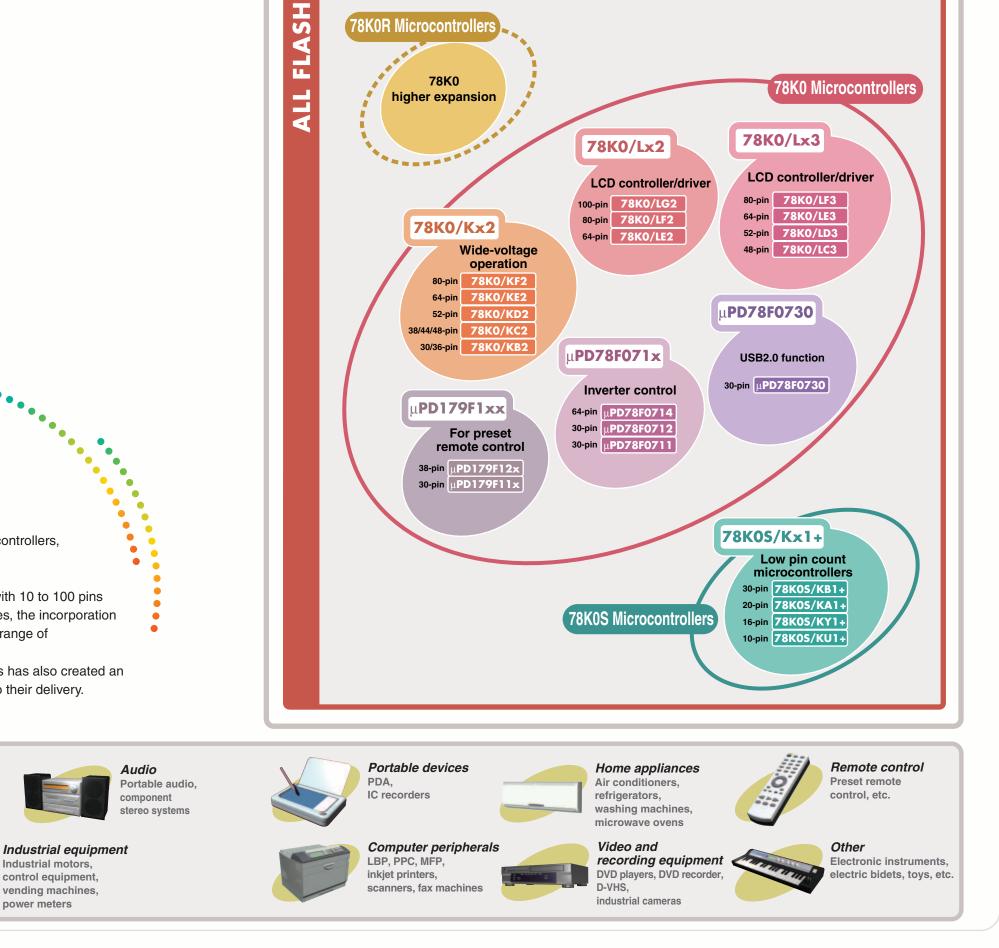


Pamphlet U17380EJ9V0PF

Cameras Digital still cameras, digital video cameras, SLR cameras







Flash microcontrollers can boost the competitiveness of your systems. **Based on this concept, we are shifting** to "All Flash".



Flash microcontrollers offer overwhelming advantages.

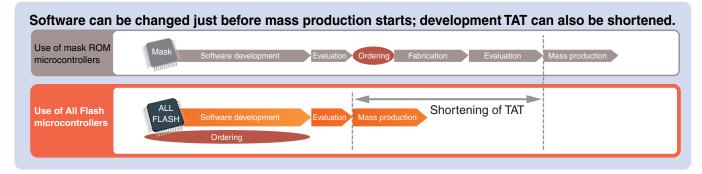
Compared to mask ROM microcontrollers, flash microcontrollers definitely contribute to speeding up system development. Microcontrollers can be ordered before program completion, programs can be written even after the microcontroller has been mounted on the board, and thus microcontroller order placement and program development can be done concurrently, allowing TAT to be shortened as a result.

In addition, when flash microcontrollers are used for products with an ample lineup or that are localized for specific regions, ordering costs necessitated by mask ROM microcontrollers can be reduced and purchase and stock management costs can be slashed.



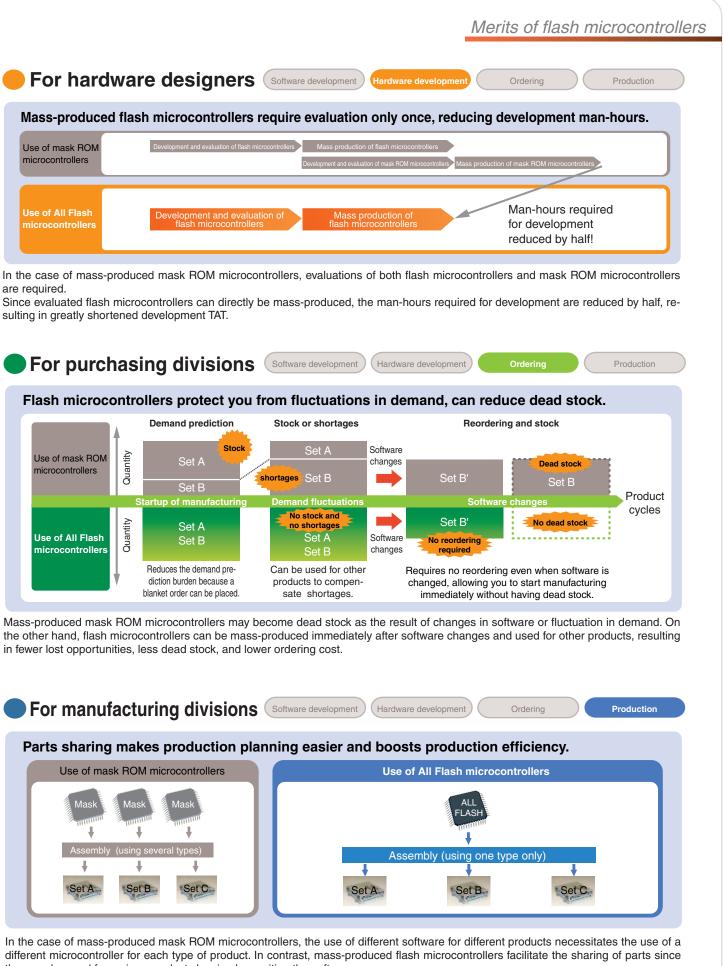
Orderina Production

Α



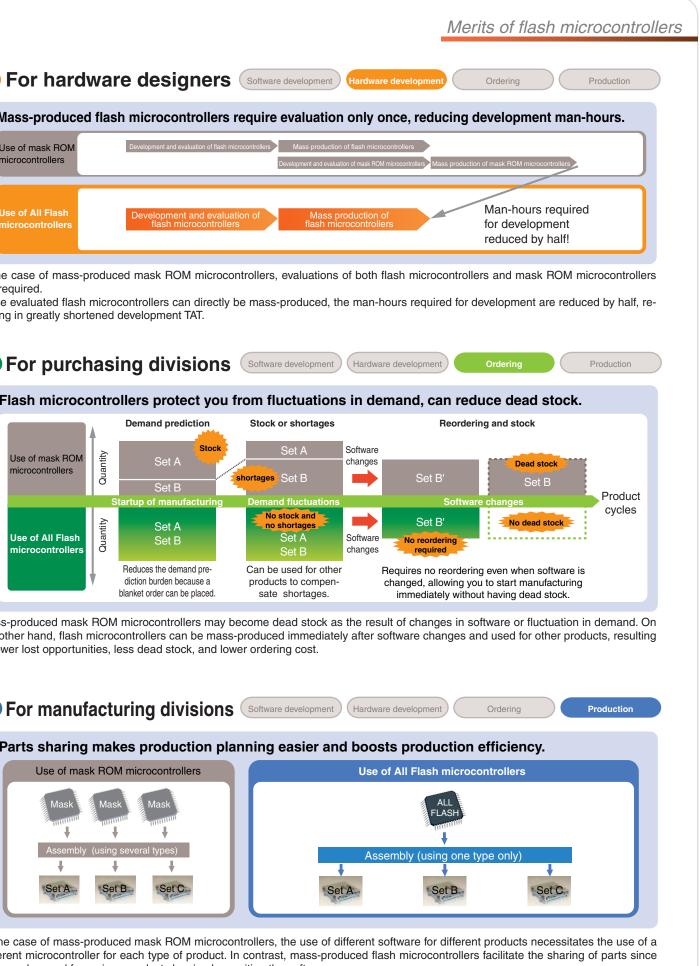
Since mask ROM microcontrollers cannot be ordered until their specifications are finalized, last-minute software changes can be problematic

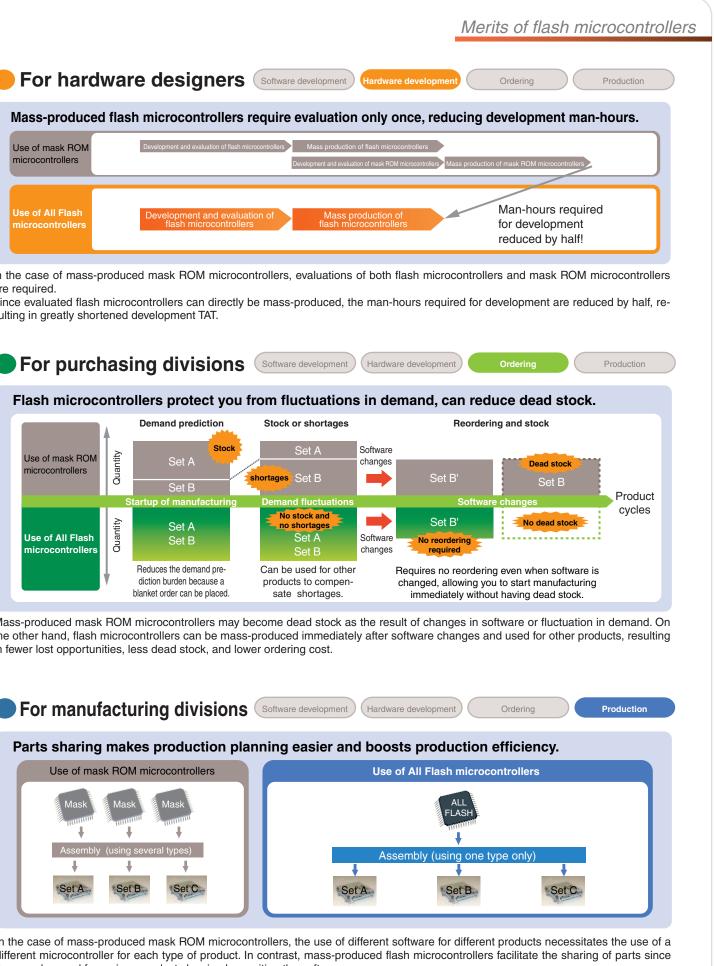
On the other hand, specifications for flash microcontrollers can be changed just prior to the start of mass production. Thus orders for flash microcontrollers can be placed while the software is still being developed, allowing the development TAT to be shortened.

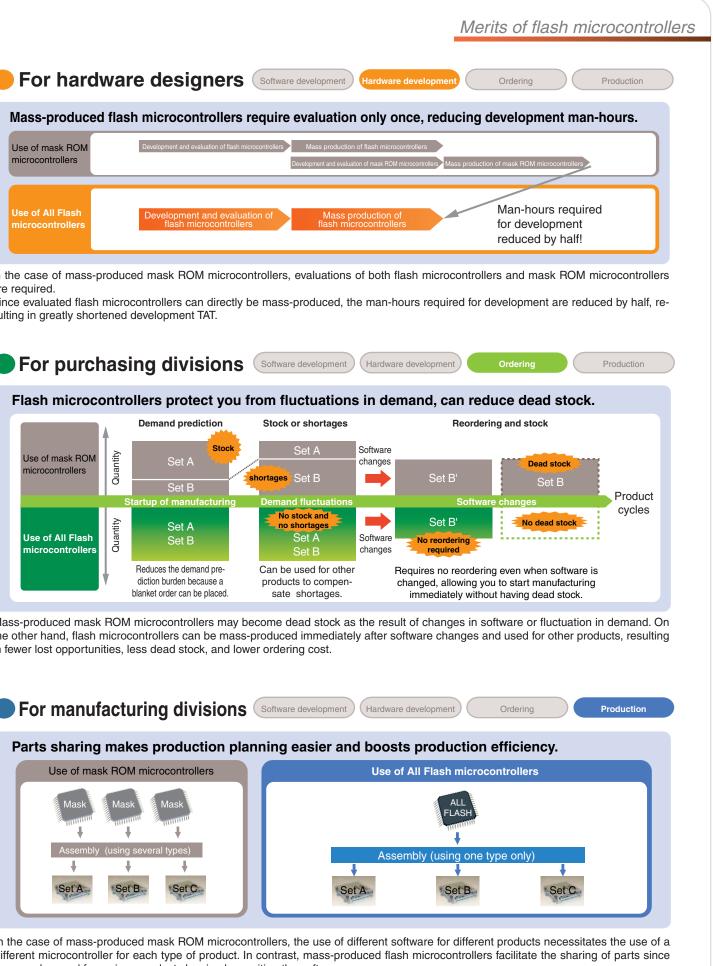


are required.

sulting in greatly shortened development TAT.







they can be used for various products by simply rewriting the software.

LL F L A S H

Unsure about flash microcontrollers? NEC Electronics can dispel your concerns in flash microcontrollers.



"Reliability" is the concept.

Compared to mask ROM microcontrollers, flash microcontrollers definitely speed up system development. On the other hand, they are often considered as expensive and available in limited configurations. NEC Electronics has

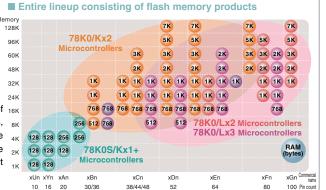
successfully cleared various hurdles by adapting development, production, sales, and distribution processes specifically for flash microcontrollers, to offer reliable microcontrollers that are attractive in all respects.

Large selection

Isn't the lineup limited?

A We offer enhanced 216 products

To respond to demands for various types of microcontrollers, we offer a range of 16K 216 All Flash 8-bit microcontrollers featuring various pin counts, ROM capacities, 8K packages, etc. Among these, the 78K0/Kx2, 78K0/Lx2, and µPD78F071x feature 4K 128 128 256 256 an operation speed of 20 MHz, and the 78K0/Kx2, 78K0/Lx2, and 78K0/Lx3 feature 2K 128 128 128 128 a wide power supply range of 1.8 to 5.5 V. Our large selection allows you to select the best product to suit your needs.

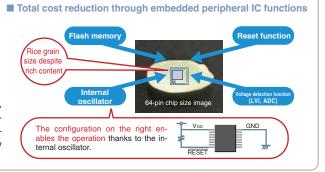


Low cost

Are these flash memory products expensive?

Our low prices overturn conventional notions.

We have drastically reduced costs through the application of new processes, etc., overturning the conventional notion that flash microcontrollers are expensive. Our microcontrollers use flash memory instead of EEPROM[™], an internal oscillator, a voltage detection function (LVI), a reset function, and various other functions normally provided externally, which translates into considerably lower total system cost for you.

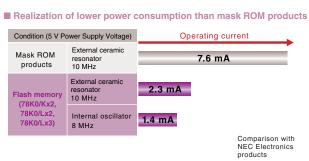


Low power consumption

Isn't the power consumption large?

About 1/3 that of mask ROM products. A

Compared to the 7.6 mA operating current of conventional mask ROM products at 5 V/10 MHz operation (external ceramic resonator), the 78K0/Kx2, 78K0/Lx2, and 78K0/Lx3 products have a low operating current of 2.3 mA at 10 MHz operation (external ceramic resonator), and just 1.4 mA at 8 MHz operation (internal oscillator) under the same conditions. Thus lower power consumption than that of conventional mask ROM products can be achieved with our flash microcontrollers.



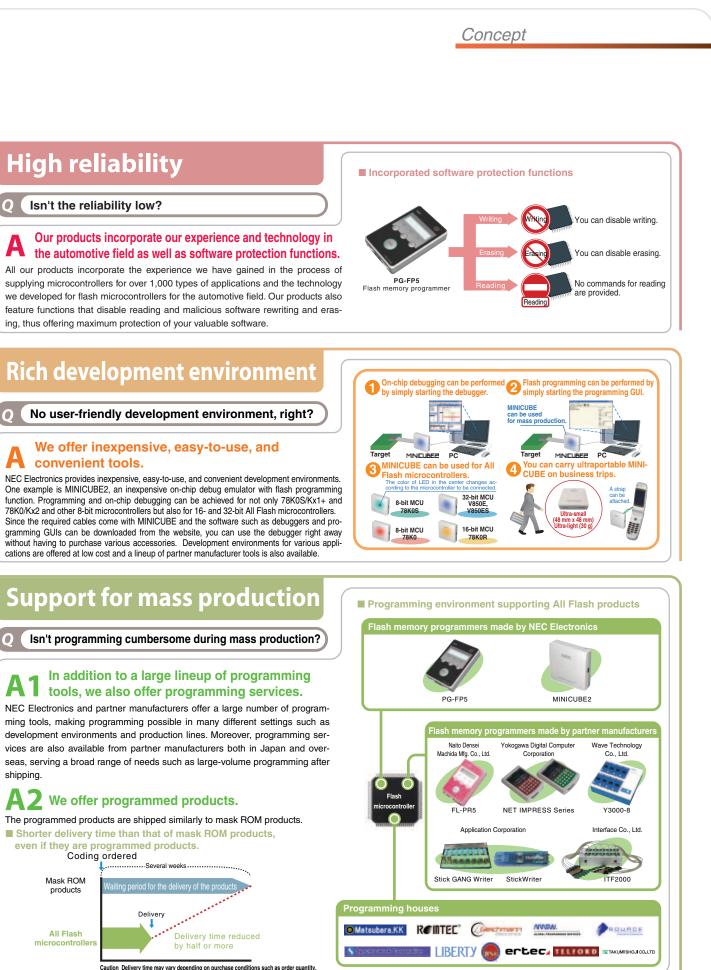
Our products incorporate our experience and technology in the automotive field as well as software protection functions. All our products incorporate the experience we have gained in the process of supplying microcontrollers for over 1,000 types of applications and the technology

One example is MINICUBE2, an inexpensive on-chip debug emulator with flash programming function. Programming and on-chip debugging can be achieved for not only 78K0S/Kx1+ and 78K0/Kx2 and other 8-bit microcontrollers but also for 16- and 32-bit All Flash microcontrollers. Since the required cables come with MINICUBE and the software such as debuggers and programming GUIs can be downloaded from the website, you can use the debugger right away without having to purchase various accessories. Development environments for various appli cations are offered at low cost and a lineup of partner manufacturer tools is also available.

Support for mass production

In addition to a large lineup of programming





Large selection (1/2)

We offer flash microcontrollers in various packages and ROM or RAM sizes,

allowing you to select the best flash microcontroller for your product or application.

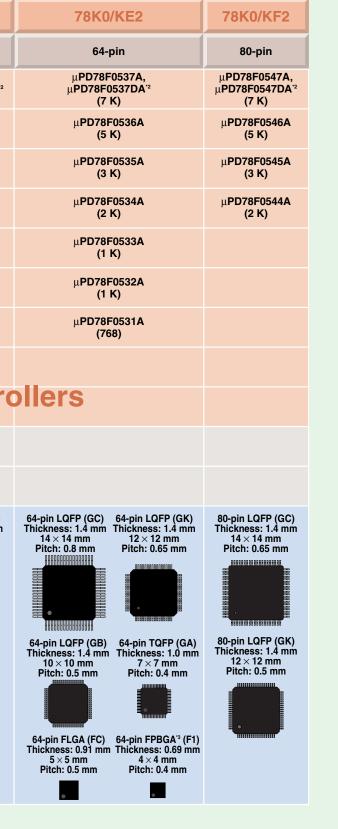
Commercial Name	78K0S/KU1+	78K0S/KY1+	78K0S/KA1+	78K0S/KB1+	78K0/KB2		78K0/KC2		78K0/KD2
Pin Count ROM (bytes)	10-pin	16-pin	20-pin	30/32-pin	30/36-pin	38-pin	44-pin	48-pin	52-pin
128 K	Product name (RAM (bytes))								μPD78F0527A, μPD78F0527DA ^{·2} (7 K)
96 K									μ PD78F0526A (5 K)
60 K								μ PD78F0515A, μ PD78F0515DA ⁻² (3 K)	μ PD78F0525A (3 K)
48 K								μ PD78F0514A (2 K)	μ PD78F0524A (2 K)
32 K					μPD78F0503A, μPD78F0503DA ⁻² (1 K)	μPD78F0513A, μPD78F0513DA ^{·2} (1 K)	μPD78F0513A, μPD78F0513DA² (1 K)	μ PD78F0513A (1 K)	μ PD78F0523A (1 K)
24 K	78K0	S/Kx1+ M	licrocontr	ollers	μ PD78F0502A (1 K)	μ PD78F0512A (1 K)	μ ΡD78F0512A (1 K)	μ PD78F0512A (1 K)	μ PD78F0522A (1 K)
16 K	(Low Pi	in Count	Microcon	trollers)	μ PD78F0501A (768)	μ PD78F0511A (768)	μ PD78F0511A (768)	μ PD78F0511A (768)	μ PD78F0521A (768)
8 K				μ PD78F9234 (256)	μ ΡD78F0500A (512)				
4 K	μ PD78F9202, μ PD78F9502 (128)	μ PD78F9212, μ PD78F9512 (128)	μ PD78F9222 (256)	μ PD78F9232 (256)			78K0/K	x2 Micr	ocontro
2 K	μPD78F9201, μPD78F9501 (128)	μ PD78F9211, μ PD78F9511 (128)	μ PD78F9221 (128)						
1 K	μPD78F9200, μPD78F9500 (128)	μPD78F9210, μPD78F9510 (128)							
	10-pin SSOP (MA) Thickness: 1.2 mm 5.72 mm (225) Pitch: 0.65 mm	16-pin SDIP ^{*1} (CS) Thickness: 2.8 mm 7.62 mm (300) Pitch: 1.778 mm	20-pin SDIP (CS) Thickness: 2.8 mm 7.62 mm (300) Pitch: 1.778 mm	32-pin SDIP (CS) Thickness: 2.8 mm 7.62 mm (300) Pitch: 1.778 mm	30-pin SSOP (MC) Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	38-pin SSOP (MC) Thickness: 1.7 mm 7.62 mm (300) Pitch: 0.65 mm	44-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.8 mm	48-pin LQFP (GA) Thickness: 1.4 mm 7 × 7 mm Pitch: 0.5 mm	52-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.65 mm
)))))						
Package		16-pin SSOP (GR) Thickness: 1.44mm 5.72mm (225) Pitch: 0.65mm	20-pin SSOP (MC) Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	30-pin SSOP (MC) Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	36-pin FLGA (FC) Thickness: 0.91mm 4 × 4mm Pitch: 0.5mm		8686888888		
			•						
		16-pin WLBGA' ¹ (FH) Thickness: 0.4 mm 2 × 2.3 mm Pitch: 0.5 mm	20-pin WLBGA ^{·3} (FH) Thickness: 0.4 mm 2.1 × 2.6 mm Pitch: 0.5 mm						
		•							

*1 μPD78F9210, 78F9211, and 78F9212 only *2 Supports on-chip debugging of 78K0/Kx2 *3 Under developme Remark The packages are shown in their actual size.

Pamphlet U17380EJ9V0PF

78K0S/Kx1+ 78K0/Kx2

Pamphlet U17380EJ9V0PF



Large selection (2/2)

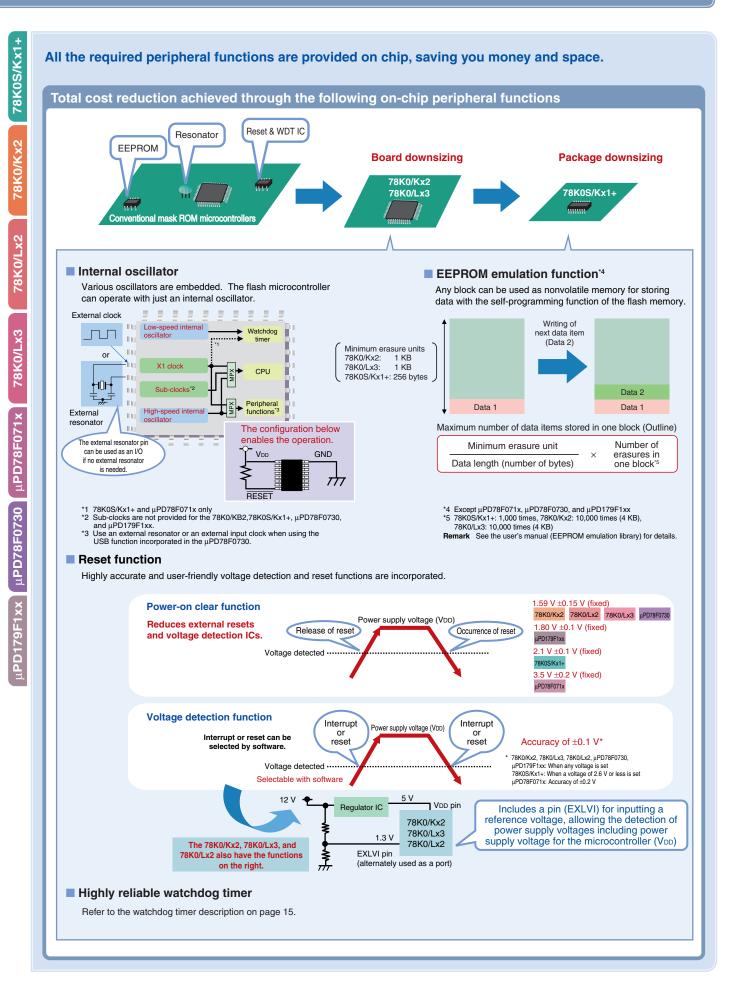
We offer flash microcontrollers in various packages and ROM or RAM sizes, allowing you to select the best flash microcontroller for your product or application

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Commercial Name	μ PD17	9F1xx	μ PD78F0730	μ ΡD78	3F071x	78K0/LC3	78K0/LD3	78K0/LE3	78K0/LF3	78K0/LE2	78K0/LF2	78K0/LG2
Pin Count OM (bytes)	30-pin	38-pin	30-pin	30-pin	64-pin	48-pin	52-pin	64-pin	80-pin	64-pin	80-pin	100-pin
128 K	Product name (RAM (bytes))											μPD78F0397, μPD78F0397D ⁻² (7 K)
96 K											μPD78F0376, μPD78F0386, μPD78F0376D ² , μPD78F0386D ² (5 K)	μ ΡD78F0396 (5 K)
60 K								μPD78F0445, μPD78F0455, μPD78F0465 ^{*1} (2 K)	μPD78F0485, μPD78F0495 ^{*1} , μPD78F0475 (2 K)		μ PD78F0375, μ PD78F0385 (3 K)	μ ΡD78F0395 (3 K)
48 K								μΡD78F0444, μΡD78F0454, μΡD78F0464 ^{*1} (2 K)			μ PD78F0374, μ PD78F0384 (2 K)	μ ΡD78F0394 (2 K)
32 K	μ PD179F114 (1 K)	μ PD179F124 (1 K)			μ PD78F0714 (1 K)	μ PD78F0403, μ PD78F0413 (1 K)	μPD78F0423, μPD78F0433 (1 K)	μΡD78F0443, μΡD78F0453, μΡD78F0463 ^{*1} (1 K)	μΡD78F0483, μΡD78F0493 ^{*1} , μΡD78F0473 (1 K)	μPD78F0363, μPD78F0363D ⁻² (1 K)	μ PD78F0373, μ PD78F0383 (1 K)	μ ΡD78F0393 (1 K)
24 K	μ PD179F113 (1 K)	μ PD179F123 (1 K)				μPD78F0402, μPD78F0412 (1 K)	μPD78F0422, μPD78F0432 (1 K)	μΡD78F0442, μΡD78F0452, μΡD78F0462 ⁻¹ (1 K)	μΡD78F0482, μΡD78F0492 ^{*1} , μΡD78F0472 (1 K)	μ ΡD78F0362 (1 K)	μ PD78F0372, μ PD78F0382 (1 K)	
16 K	μ PD179F112 (768)	μ PD179F122 (768)	μ ΡD78F0730 (3 K)	μ PD78F0712 (768)		μPD78F0401, μPD78F0411 (768)	μPD78F0421, μPD78F0431 (768)	μΡD78F0441, μΡD78F0451, μΡD78F0461 ^{*1} (768)		μ ΡD78F0361 (768)		
8 K	μ PD179F111 (512)			μ PD78F0711 (768)		μPD78F0400, μPD78F0410 (512)	μPD78F0420, μPD78F0430 (512)					_
4 K	μ PD179F110 (512)							crocontr	ollers		8K0/Lx2	
2 K		rollers for	USB	Microcont						Micr	ocontro	llers
1 K			Micro- controllers	Inverter	Control							
	30-pin SSOP (MC) Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	38-pin SSOP (MC) Thickness: 1.7 mm 7.62 mm (300) Pitch: 0.65 mm	30-pin SSOP (MC) Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	30-pin SSOP (MC) Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	64-pin TQFP (GK) Thickness: 1.0 mm 12 × 12 mm Pitch: 0.65 mm	48-pin LQFP (GA) Thickness: 1.4 mm 7 × 7 mm Pitch: 0.5 mm	52-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.65 mm	64-pin LQFP (GK) Thickness: 1.4 mm 12 × 12 mm Pitch: 0.65 mm	80-pin LQFP (GC) Thickness: 1.4 mm 14 × 14 mm Pitch: 0.65 mm	64-pin LQFP (GK) Thickness: 1.4 mm 12 × 12 mm Pitch: 0.65 mm	80-pin LQFP (GC) Thickness: 1.4 mm 14 × 14 mm Pitch: 0.65 mm	100-pin LQFP (GC Thickness: 1.4 mr 14 × 14 mm Pitch: 0.5 mm
Package								64-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.5 mm	80-pin LQFP (GK) Thickness: 1.4 mm 12 × 12 mm Pitch: 0.5 mm	64-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.5 mm	80-pin LQFP (GK) Thickness: 1.4 mm 12 × 12 mm Pitch: 0.5 mm	

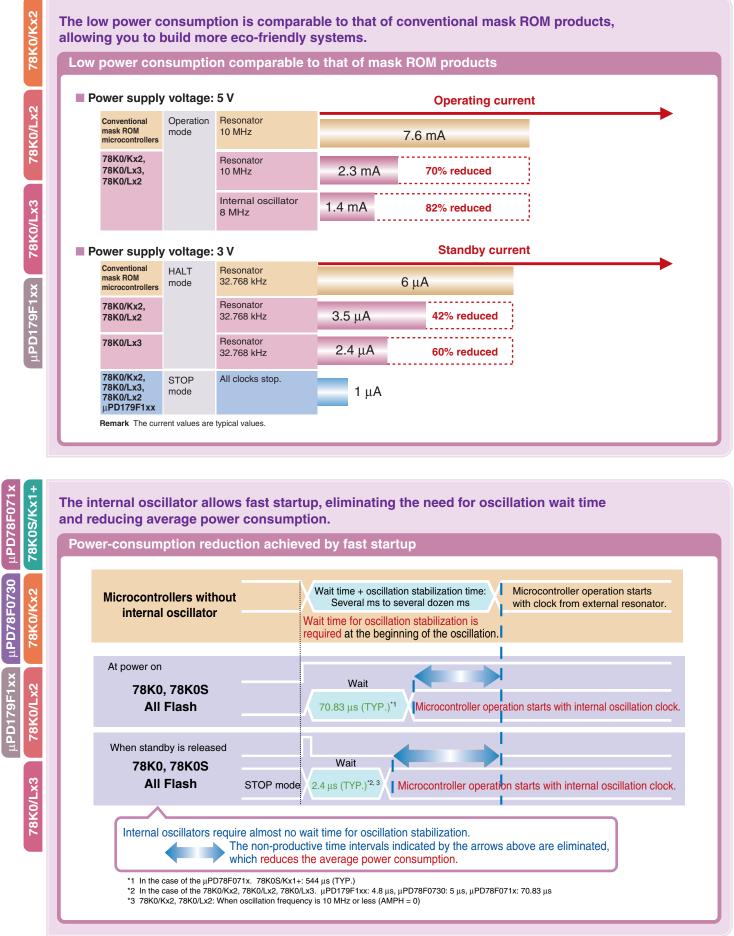
78K0/Lx2

Low cost



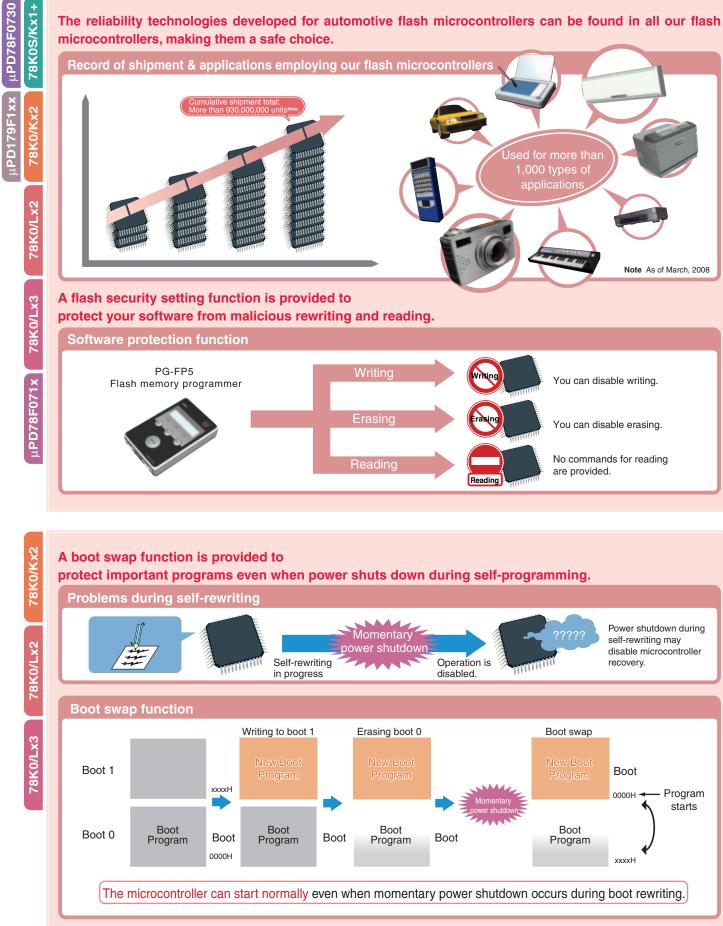
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Low power consumption



μ**Ρ**D179F1xx

High reliability



Pamphlet U17380EJ9V0PF

μ**Ρ**D78F071x The enhanced watchdog timer (WDT) offers improved reliability 78K0S/Kx1 and functionality equivalent to that of an external WDT. WDT independent from CPU μ**ΡD78F0730** cillation clock kHz (TY WDT Independent from CPU CPU Main peripheral clock μ**Ρ**D179F1xx nction 78K0/Lx2 This configuration is the same as that in which an external watchdog timer is connected. 78K0/Lx3 The WDT does not stop even if the main clock stops. μ**Ρ**D179F1xx The 78K0/Kx2, 78K0/Lx2, 78K0/Lx3, and µPD179F1xx have more reliable functions. Window WDT Outline of Window WDT The Window WDT can 78K0/Lx2 WDT starts ٢ counting 78K0/Lx3 Count

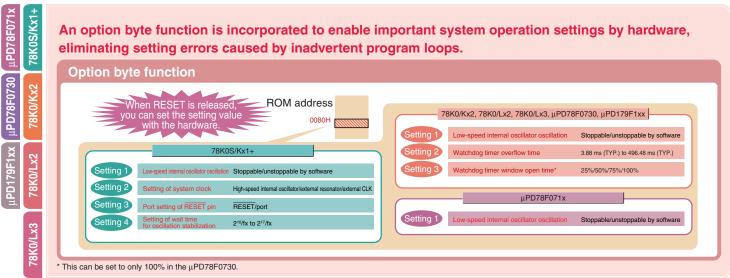
Instruction fo

clearing the count

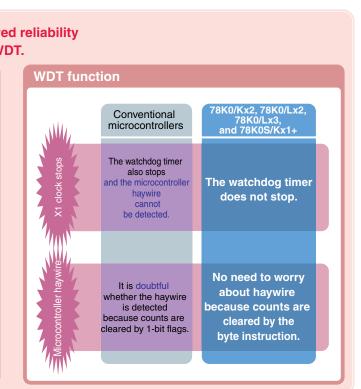
During the closure,

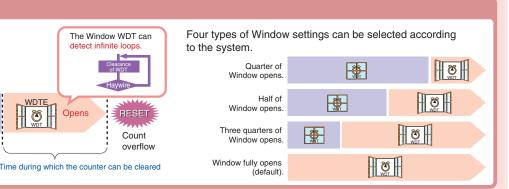
clearance is rejected.

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Rich development environment (1/2)

We provide inexpensive, easy-to-use, and convenient development environments, allowing you to select the best development environment according to the device and development conditions.

Lineup of development environments oard supplied with Applilet[®] EZ Starter kit for Test boards for MINICUBE2 Pitch conversion board for simple software creation For 20-pin For 20-pin DIP SSOP package package For 78K0S/KB1+ DIP conversion board Applilet EZ Microcontroller training kit 78K0S - 118 00000 EZ-0001 ReferSTAR 78K*1 EZ-0002 CT-207*1 QB-78K0SKB1-TB FB-78F9222MC*2 board* Microcontroller training kit For 78K0/KF2 For 78K0/LG2 For 78K0/KF2 For 78K0/LG2 Test (ReferSTAR 78K upgrade kit*1) TK-78K0/KF2*3 EZ-0003 QB-78K0KF2-TB QB-78K0LG2-TB For 78K0/LF3 QB-78K0LF3-T Debugging/verification Programming ssembler (RA78K0S) (PM+ is included.) Simulator (SM+ for 78K0S/Kx1+) Flash memory programmer Compiler (CC78K0S) On-chip debug emulator . • == with flash programming function PG-FP5 Full-function in-circuit emulator (IECUBE®) (MINICUBE2) 78K0S Device driver configurator (Applilet for 78K0S/Kx1+) FL-PR5*2 QB-78K0SKX1 QB-MINI2 Software package (SP78K0S) Assembler (RA78K0) (PM+ is included.) Simulator Flash memory programme (SM+ for 78K0/Kx2)*4 Compiler (CC78K0) On-chip debug emulator . • == with flash programming function PG-FP5 (MINICUBE2) Full-function in-circuit emulator Device driver configurator (Applilet2 for 78K0/Kx2) (Applilet2 for 78K0/Lx2) (IECUBE) -----FL-PR5*2 QB-MINI2 QB-78K0KX2 QB-78K0LX2 QB-78K0LX3 Software package (SP78K0) QB-780714 QB-780731 QB-179F124 *1 Made by Sunhayato Corporation *2 Made by Naito Densei Machida Mfg. Co., Ltd. *3 Made by Application Corporation *4 Not supported by the μ PD179F1xx.

+LXX/SUX8/	Development flow Example of inexpensive	development environm
8		78K0S/Kx1+ 78K0/Kx2
78K0/KX2		CB-78K0SKB1-TB CB-78K0KF2-TB ОВ-78К0СКР2-TB ОВ-78К0КР2-TB
78K0/Lx2		On-chip debug emulator wi
-11		
78K0/Lx3		
XL/0-	Create software with Applilet*1	
	assembler/compiler, and device	, Perform debugging wit file.
μΡD78F0730 μΡD78F071x	I need software tools.	I want to perform the microcontroller conn
	All the required software is available in one packages (SP78KOS, SP78KO) The software package includes the following. • Assembler package • Assembler • Linker • Object converter • Librarian List converter	A simplified emula MINICUBE2 (On-chip debug e with flash progra •QB-MINI2 (78K0S/Kx1+, 78K0/Kx2, 7 78K0/Lx3, μPD78F071x, μ μPD179F1xx supported)
	Structured assembler preprocessor PM+ C compiler	A full-function emul
	 Integrated debugger*2 System simulators (SM+ for 78K0S/Kx1+, SM+ for 78K0/Kx2) Remark The assembler package, C compiler, and integrated debugger are also sold separately. 	IECUBE (Full-function in-circui •QB-78K0SKX1 (For 78K0S, •QB-78K0KX2 (For 78K0/Kx •QB-78K0LX2 (For 78K0/Lx •QB-78K0LX3 (For 78K0/Lx •QB-780714 (For μPD78F07 •QB-780731 (For μPD78F07 •QB-179F124 (For μPD179F
	*1 Not supported by the μPD179F1xx. *2 ID78K0S-NS only. The ID78K0S-QB and *3 Made by Naito Densei Machida Mfg. Co.,	
	For details on tools, access these URLs.	http://www.nece

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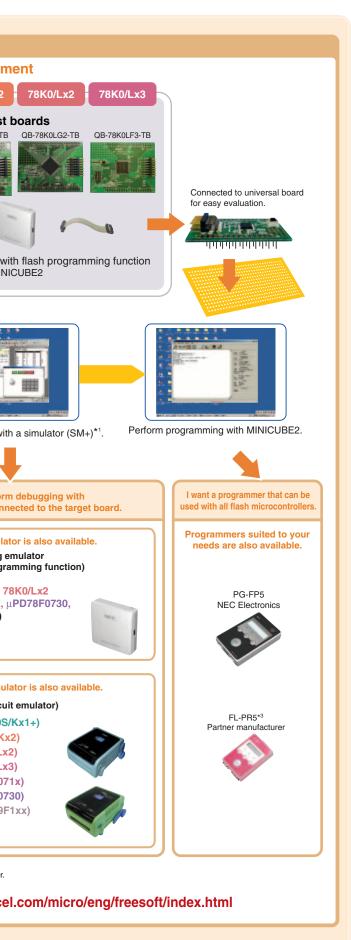
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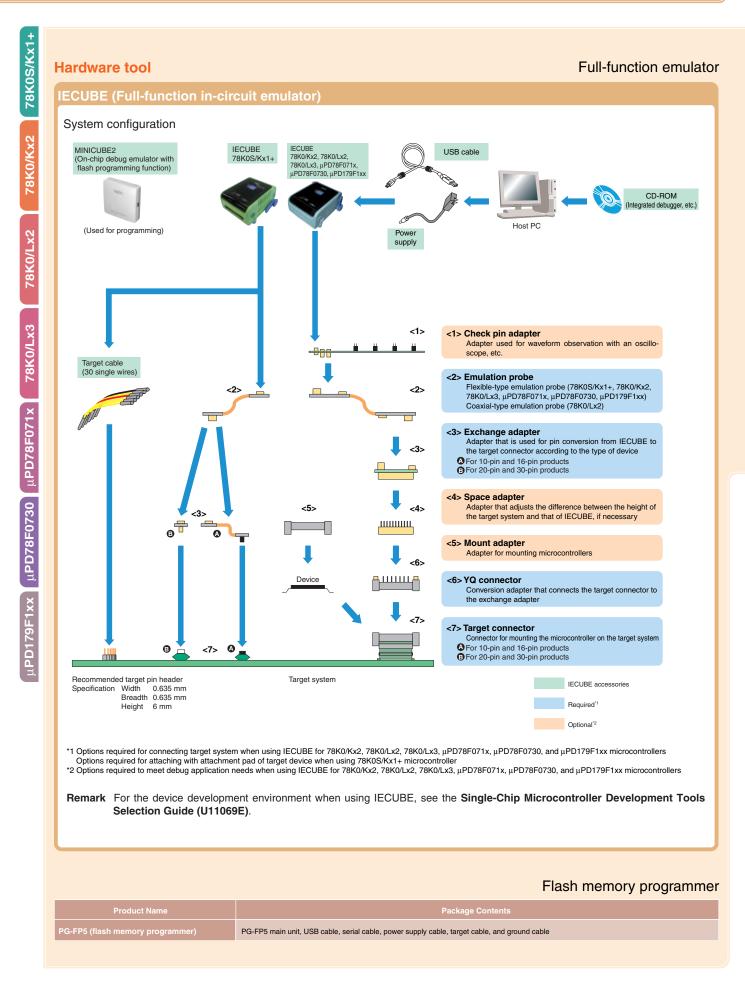
78K0S/Kx1+

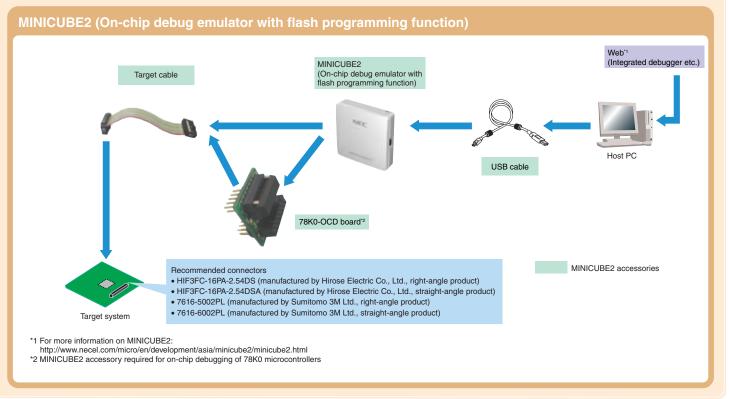
78K0/Lx3

μΡD179F1xx μΡD78F0730 μΡD78F071x



Rich development environment (2/2)





78K0S/Kx1+	Commercial Name	Package	Software Package	C Compiler Package	Assembler Package	Integrated Debugger	System Simulator	Device File
ö	78K0S/KU1+	10-pin SSOP (5.72 mm (225))	Tuonago	ruonugo	l'uonugo	Destagger	Cintalator	
¥		16-pin SDIP (7.62 mm (300))						
8	78K0S/KY1+	16-pin SSOP (5.72 mm (225))						
		16-pin WLBGA (2 × 2.3 mm)					014 (***	
		20-pin SDIP (7.62 mm (300))	SP78K0S*2	CC78K0S	RA78K0S	ID78K0S-QB	SM+ for	DF789234
	78K0S/KA1+	20-pin SSOP (7.62 mm (300))					78K0S/Kx1+*4	
2		20-pin WLBGA (2.1 × 2.6 mm)*1						
78K0/Kx2	70//00///01	30-pin SSOP (7.62 mm (300))						
	78K0S/KB1+	32-pin SDIP (7.62 mm (300))						
Ϋ́	78K0/KB2	30-pin SSOP (7.62 mm (300))						
00	70K0/KD2	36-pin FLGA (4 × 4 mm)						
78K0/Kx2		38-pin SSOP (7.62 mm (300))						
	78K0/KC2	44-pin LQFP (10 × 10 mm)						
		48-pin LQFP (7 × 7 mm)						
78K0/Lx2	78K0/KD2	52-pin LQFP (10 × 10 mm)						
X		64-pin LQFP (14 × 14 mm)					SM+ for	DF780547
		64-pin LQFP (12 × 12 mm)					78K0/Kx2	
9	78K0/KE2	64-pin LQFP (10 × 10 mm)						
×		64-pin TQFP (7 × 7 mm)						
78K0/Lx2		64-pin FLGA (5 \times 5 mm) 64-pin FPBGA (4 \times 4 mm) ^{*1}						
		80-pin LQFP (14 × 14 mm)						
	78K0/KF2	80-pin LQFP (12 × 12 mm)						
		30-pin SSOP (7.62 mm (300))						
(C)	μ PD179F1xx	38-pin SSOP (7.62 mm (300))	SP78K0*3	CC78K0	RA78K0	ID78K0-QB		DF179124
78K0/Lx3	uPD78F0730	30-pin SSOP (7.62 mm (300))						DF780731
		30-pin SSOP (7.62 mm (300))						
ž	μ PD78F071x	64-pin LQFP (12 × 12 mm)						DF780141
$\overline{\mathbf{\omega}}$		64-pin LQFP (12 × 12 mm)						
~	78K0/LE2	64-pin LQFP (10 × 10 mm)						
	78K0/LF2	80-pin LQFP (14 × 14 mm)						DF780397
		80-pin LQFP (12 × 12 mm)					-	
	78K0/LG2	100-pin LQFP (14 × 14 mm)						
	78K0/LC3	48-pin LQFP (7 × 7 mm)						
	78K0/LD3	52-pin LQFP (10 × 10 mm)						
	78K0/LE3	64-pin LQFP (12 × 12 mm)*1						DF780495
		64-pin LQFP (10 × 10 mm)*1						01700400
	78K0/LF3	· · · · · · · · · · · · · · · · · · ·						
	78K0/LF3	80-pin LQFP $(10 \times 10 \text{ mm})^{*1}$ 80-pin LQFP $(12 \times 12 \text{ mm})^{*1}$						

*3 The CC78K0 and RA78K0 are packaged in the SP78K0. *4 The 78K0S/KU1+ is not supported. Support is planned with the next upgrade.

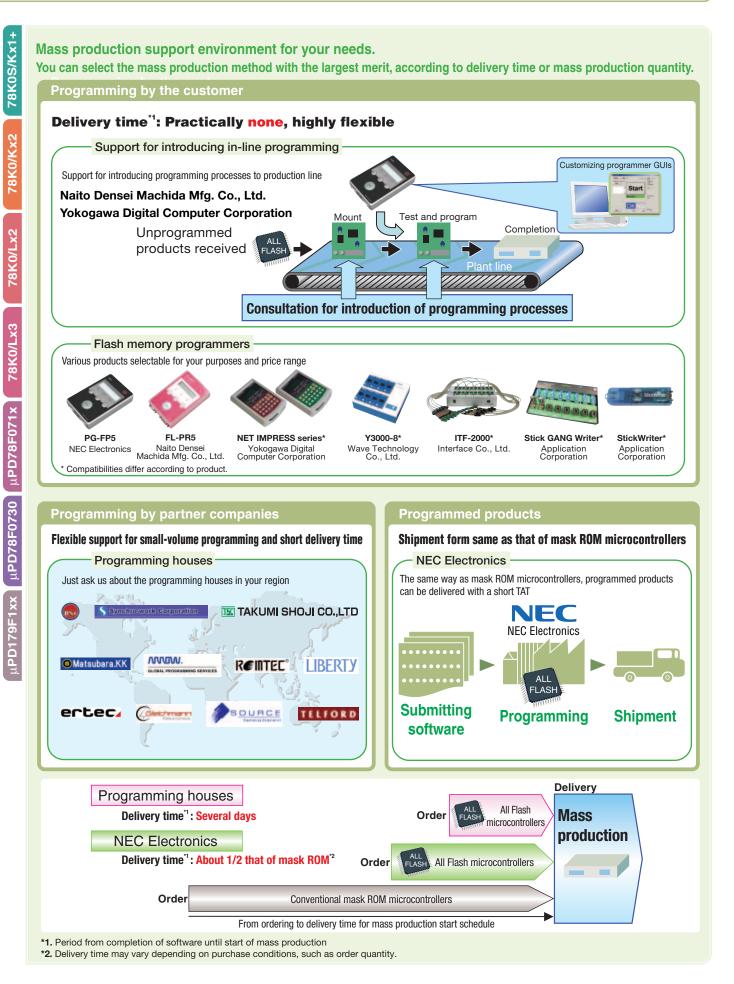
F L A S H

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Α

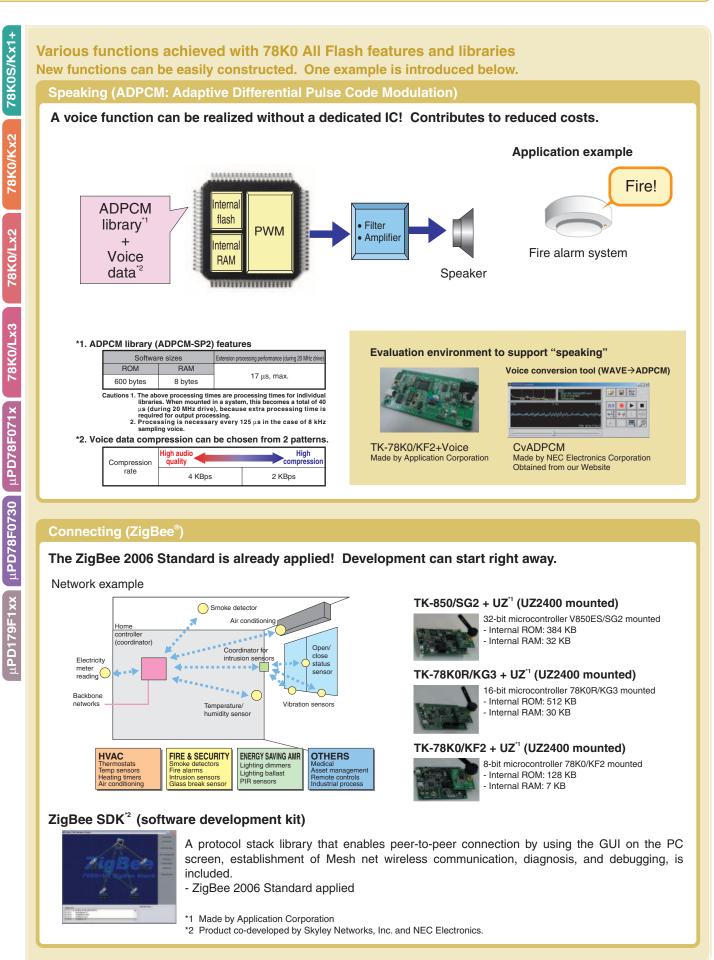
Simplified emulator

Support for mass production



Pamphlet U17380EJ9V0PF

Application examples



Product specifications (1/2)

	CPU Core	ə		78K0S						78K0			78K0	78K0
Commercial			78K0S/KU1+	78K0S/KY1+	78K0S/KA1+ 78K0S/KB	1+ 78K0/KB	2	78K0/KC2		78K0/KD2	78K0/KE2	78K0/KF2	µPD179F1xx	μPD78F0730
Pin count			10-pin	16-pin	20-pin 30/32-p			44-pin	48-pin	52-pin	64-pin	80-pin	30-pin 38-pin	· ·
Product nan	ne		8F9 8F9 8F9	μРD78F9502 μΡD78F9210 μΡD78F9211 μΡD78F9212 μΡD78F9510 μΡD78F9511	µРD78F9512 µРD78F9221 µРD78F9222 µРD78F9232	μΡD78F0500A μΡD78F0501A μΡD78F0501A	μΡD78F0503A μΡD78F0511A μΡD78F0512A μΡD78F0513A	μΡD78F0511A μΡD78F0512A μΡD78F0513A	μΡD78F0511A μΡD78F0512A μΡD78F0513A μΡD78F0514A μΡD78F0514A	μРD78F0521A μΡD78F0522A μΡD78F0522A μΡD78F0523A μΡD78F0525A μΡD78F0526A μΡD78F0526A	μΡD78F0531A μΡD78F0532A μΡD78F0532A μΡD78F0533A μΡD78F0535A μΡD78F0536A μΡD78F0536A	μΡD78F0544A μΡD78F0545A μΡD78F0546A μΡD78F0546A	μΡD179F110 μΡD179F111 μΡD179F112 μΡD179F113 μΡD179F122 μΡD179F122	μΡD179F124 μΡD78F0730
Flash memo			1K 2K 4K 1K 2K 4	4K 1K 2K 4K 1K 2K 4	K 2K 4K 4K 8	K 8 K 16 K 24 F	K 32 K 16 K 24 K 32 K	16 K 24 K 32K	16 K 24 K 32 K 48 K 60	K 16 K 24 K 32 K 48 K 60 K 96 K 128			4 К 8 К 16 К 24 К 32 К 16 К 24 К 3	2 K 16 K
	Bank		-	-		-	-	-	-	- 4 6	- 4 6		-	-
RAM (bytes) Power			128	128	128 256 256	512 768 1 K	. 1K /68 1K 1K	768 1 K 1K	768 1 K 1 K 2 K 3 K		. 768 1K 1K 2K 3K 5K 7K	C 2K 3K 5K 7K	512 512 768 1 K 1 K 768 1 K	
supply	Normal opera			2.0 to 5.5 V 2.7 to 5.5 V						1.8 to 5.5 V 2.7 to 5.5 V			1.8 to 3.6 V 2.0 to 3.6 V	4.0 to 5.5 V 4.0 to 5.5 V
voltage Minimum ins	struction exect	rogramming mode ution time	0.20 us (10 MHz: Vpp :	= 4.0 to 5.5 V)/0.33 μs (6 MHz: \	$n_{DD} = 3.0 \text{ to } 5.5 \text{ V})/$				0.10 us (20 MHz: Vpp =	= 4.0 to 5.5 V)/0.20 μs (10 MHz: VDD =	2.7 to 5.5 V)/		0.5 μs (4 MHz: V _{DD} = 2.0 to 3.6 V)/	0.125µs (16 MHz;
				$= 2.7 \text{ to } 5.5 \text{ V})/1.0 \ \mu\text{s} (2 \text{ MHz: Vi})$						$0 \ \mu s \ (5 \ MHz: V_{DD} = 1.8 \ to \ 5.5 \ V)$	2 to one ty		$1 \ \mu s (2 \ MHz; V_{DD} = 1.8 \ to 3.6 \ V)$	V _{DD} = 4.0 to 5.5 V)
Clock	Main High	-speed system clock	Ceramic*2	2/crystal*2/external clock: 1 to 10	0 MHz				Ceramic/crys	stal/external clock: 1 to 20 MHz			Ceramic/crystal/external clock: 1 to 4 M	Hz *5
	High-	speed internal oscillator		8 MHz ±5%						8 MHz ±5%			4 MHz ±2%	16 MHz ±10%
	Sub-clock		-	-		-				Crystal/external clock: 32.768 kHz			-	-
1/O marta	· ·	ternal oscillator	240 kHz (TYP.) (wa	atchdog timer and clock for 8-b						dog timer and clock for 8-bit timer TM			240 kHz (TYP.) (watchdog timer and clock for 8-bit timer TI	
I/O ports	Total		8	14	17 26	23	31	37	41	45	55	71	26 34	19
	CMOS I/O CMOS input		1	13	15 24	21	29	33	37	40	50	66	25 33	17
			1	1	1 1	_	-	-	-	- 1	- 1	-	1 1	-
	CMOS output N-ch open-dra				_	- 2	-	-	4	4	4	4	– – – – – – – N-ch: 24, P-ch: 1 ^{*3} N-ch: 32, P-ch	- 1*3 2
Timer	16-bit timer	Number of channels	1 -	- 1		1	4	4	4	4	1 2	2	1	1 2
	(TM0)	Function	Interval tim	er/external event counter/PPG th measurement/square-wave o one-shot pulse output					pulse width me	kternal event counter/PPG output/ assurement/square-wave output/ ne-shot pulse output			Interval timer/external event counter, pulse width measurement/square- one-shot pulse output	
	8-bit timer	Number of channels	1	1	1 1	2	2	2	2	2	2	2	2	1
	(TMH)	Function	Interval tir	mer/PWM output/square-wave	output					/M output/carrier generator output/			Interval timer/PWM output/cari output/square-wave outp	•
	8-bit timer	Number of channels	-	-		2	2	2	2	2	2	2	2	2
	(TM5)	Function	-	-						ternal event counter/PWM output/			Interval timer/external event cou output/square-wave outp	
	8-bit timer (TM8)	Number of channels	-	-	1 1	-	-	-	-	-	-	-	-	-
	(1110)	Function	-	-	Interval timer	-	-	-	-	-	-	-	-	-
	Watchdog tim	ner (WDT)	1	1	1 1	1	1	1	1	1	1	1	1	1
	Watch timer		-	-		-	1	1	1	1	1	1	-	-
	Real-time cou	unter (RTC)	-	-		-	-	-	-	-	-	-	-	-
Serial interface	UART (suppo	rting LIN)	-	-	1 1	1	1	1	1	1	1	1	1 (not supporting LIN)	1 (not supporting LIN)
	UART/CSI		-	-		1	1	1	1	1	1	1	-	-
	CSI		-	-		-	-	-	-	-	- 1	1	-	1
	Automatic transmit	t/receive 3-wire CSI	-	-		-	-	-	-	-	-	1	-	-
A/D		oximation (10-bit)	4 _	-	 1 1	4	6	8	8	8	8	8	-	-
converter	$\Delta\Sigma$ (16-bit)		-	-		-	_	_	_	-	_	-	_	_
Interrupt	External		2	2	4 4	6	7	7	8	8	9	9	8	4
	Internal		5 3	5 4	9 9	14	16	16	16	16	16 19	20	10	14
Maximum nu displayed in	umber of segm LCD	ents 8 commons	-	-		-	-	-	-	-	-	-	-	-
		4 commons	-	-		-	-	-	-	-	-	-	-	-
	oug (MINICUBE	2)	Supported	Supported	Supported Support		Supported*4 — Supported*4	ـــــــــــــــــــــــــــــــــــــ	— Supported				Supported	Supported
Multiplier/di	ivider		-	-	- 8-bit × 8-	oit —	-	-	16-bit × 16-b 32-bit ÷ 16-b		 16-bit × 16-bit, 32-bit ÷ 16-bit 	16-bit × 16-bit, 32-bit ÷ 16-bit	-	-
Low voltage	detector (LVI)		2.35/2.6 V ±0.1 V or 2.8	85/3.1/3.3 V ±0.15 V or 3.5/3.7/3 (Selectable by software)	8.9/4.1/4.3 V ±0.2 V		1.93/2.08/2.24/2.39/	2.55/2.70/2.85	/3.01/3.16/3.32/3.47/3.	62/3.78/3.93/4.09/4.24 V (default) ±0 electable by software)			$2.08~V^{+0.07~V}_{-0.08~V}$, 1.93 to 3.47 V ± 0.1 V, The detected voltage can be input to pins. (Selectable by soft	*7 ware)
Power-on cl	ear (POC)			2.1 V ±0.1 V						1.59 V ±0.15 V			1.8 V ±0.1 V	1.59 V ±0.15 V
Other			-	-		-	-	-	Clock output	Clock output	Clock output, buzzer output	Clock output, buzzer outpu	-	*8
Operating te	emperature		$T_A = -40 \text{ to } +85^\circ$	C (model with expanded temper	rature range)				$T_A = -40 \text{ to } +85^{\circ}\text{C} \pmod{4}$	el with expanded temperature range	planned)		$T_{A} = -40 \text{ to } +85^{\circ}\text{C}$	
*2. The μPD *3. N-ch op *4. Only sup	078F9500, 78F9 pen-drain outpu oported in the p	9501, and 78F95 ut and P-ch ope μPD78F0503DA	502 cannot connect to a cer n-drain output are alternativ , 78F0513DA, 78F0515DA, 7		F0547DA.	elopment.			*6. 240 kHz ±10% (v *7. 4.24 V ±0.1 V or 4	/external clock: 12/16 MHz vatchdog timer and clock for 8-bit tin 4.09 V \pm 0.1 V (selectable by software ed function controller				

ALL FLASH

Product specifications (2/2)

	CPU Core	;	78K0											78	10																	78K0						
ommercial	l name		μ PD78F071 x	-	78K0/LC3	3			78K0/LD3	3				78K	(0/LE3							7	78K0/LF	3				78K0/LE	2		78K0/	/LF2			78	'8K0/LG2		
n count			30-pin 64-pin		48-pin				52-pin					64	4-pin								80-pin					64-pin			80-	pin				100-pin		
oduct nan	me		μΡD78F0711 μΡD78F0712 μΡD78F0714	μΡD78F0400 μΡD78F0401 μΡD78F0402	μΡD78F0403 μΡD78F0410	μΡD78F0411 μΡD78F0412	μΡD78F0413 μΡD78F0420	μΡD78F0421 μΡD78F0422	μΡD78F0423 μΡD78F0430	μΡD78F0431 μΡD78F0432	Ш Ц 8 8 1 8	μΡD78F0442 μΡD78F0443 μΡD78F0444	μPD78F0445	μΡD78F0451 μΡD78F0452	μΡD78F0453 μΡD78F0454	uPD78F0461*1	uPD78F0462*1 uPD78F0463*1	uPD78F0464*1 uPD78F0465*1	µРD78F0471 пРD78F0472	μΡD78F0473	μΡD78F0474 μΡD78F0475	μPD78F0481	µPD78F0483	μΡD78F0484 μΡD78F0485	uPD78F0491*1	uPD78F0493*1 uPD78F0493*1	uPD78F0494*1 uPD78F0495*1	μΡD78F0361 μΡD78F0362	μΡD78F0363 μΡD78F0372	μΡD78F0373 μΡD78F0374	μΡD78F0375 μΡD78F0376	μPD78F0382 μPD78F0383	μPD78F0384		μΡD78F0393 μΡD78F0394	μΡD78F0395		
sh memo	ory (bytes) Bank		8 K 16 K 32 K	8 K 16 K 24 K	32 K 8 K	16 K 24 K	32 K 8 K	(16 K 24 K	32 K 8 K	16 K 24 K 3	2 K 16 K 2	4 K 32 K 48	K 60 K 10		32 K 48 K 60 _	K 16 K 24	4 K 32 K	48 K 60 K	16 K 24	K 32 K 4	18 K 60 K	K 16 K 24	K 32 K 4	8 K 60 k	< 16 K 2	4 K 32 K	48 K 60 k	16 K 24 K 3	2 K 24 K 32	2 K 48 K 6	0 K 96 K	24 K 32 I	K 48 K 6	60 K 96 K (32 K 48 I	K 60 K 96		
VI (bytes)				512 768 1 K	- 1 K 512	768 1 K	1 K 512	2 768 1 K	- 1 K 512	768 1 K 1	K 768 1	K 1 K 21	K 2 K 7			K 768 1	K 1 K	2 K 2 K	768 1	K 1 K '	2 K 2 K	768 1	- K 1 K 2	<u>א א א</u>	768 1	K 1 K	2 K 2 K	768 1 K	K 1 K 1	- -	4 2 K 5 K	1 1 1 1	- < 2 K '	4 3 K 5 K	1 1 2 4			
/er	Normal opera	ution mode	4.0 to 5.5 V	512 700 110	110 512	700 110	110 012	2 700 110	110 012	700 110 1	11 700 1		<u> 2</u> N <i>1</i>	1.8 to 5		100 1		211 211	700 11		211 211	700 1			100 1	K TK	211 211	700 11		K Z K C		.8 to 5.5			11(21			
ply age	Flash memory pro		4.0 to 5.5 V	2.7 to 5.5 V																																		
-	struction execu		0.10 μs (20 MHz:														2.7 to 5.5 V 0.10 μs (20 MHz: Vdd = 4.0 to 5.5 V)/0.20 μs (10 MHz: Vdd = 2.7 to 5.5 V)																					
			V _{DD} = 4.0 to 5.5 V)									0.40 μs (5																$0.10 \ \mu\text{s}$ (20 MHz: VDb = 4.0 to 5.5 V)/0.20 μs (10 MHz: VDb = 2.7 to 5.5 V) 0.40 μ s (5 MHz: VDb = 1.8 to 5.5 V)										
k	alaala	-speed system clock	0 10 20 Mil 12								Ceran	nic/crystal/	/externa	l clock: 2	2 to 10 MH	z														Ceramic	/crystal/	/externa	al clock:	: 1 to 20 I	MHz			
	clock High-s	speed internal oscillator	8 MHz ±5 % –											8 MHz	±5%													8 MHz ±5%										
	Sub-clock		-										Cr	rystal: 32	2.768 kHz													Crystal/external clock: 32.768 kHz										
	Low-speed inte	ernal oscillator	240 kHz									240 kHz	z ±10% (v	watchdo	g timer an	d clock	for 8-bi	t timer T	MH1)									240 kHz ±10% (watchdog timer and clock for 8-bit timer TMH1										
oorts	Total		15 48		30				34						46								62					24		34			26			40		
	CMOS I/O		11 40		26				30						42								58					24		34			26			40		
	CMOS input		4 8		4				4						4								4					-			-	-				-		
	CMOS output		-		-				-						-								-					-			-	-				-		
	N-ch open-drai	in	-		-				-						-								-					-			-	-				-		
r	16-bit timer (TM0)	Number of channels Function	1		1				1	pulse	e width m	Interval ti easuremen			1 ent counter output/one								1					1 Interva	1 I timer/ext	ternal eve			a outpu	2 it/pulse w oulse outp		2 easurer		
	8-bit timer	Number of channels	- 1		3				3	pulot	, widdir in	ououronnon	n, oquun		3	onorp		iput					3					2		2	aro out		2		Jul	2		
	(ТМН)	Function	- 1		5				5	Inte	rval timer	/PWM outp	out/carri		-	t /squa	are-wave	e output					5						val timer/F		put/carri	ier gene	erator o	output/squ	uare-wa	-		
	8-bit timer (TM5)	Number of channels	2		3				3						3								3					2		2			2			2		
	(1103)	Function								I	nterval tim	er/external	event co	ounter/PV	VM output	squar	re-wave	output*2										Inter	rval timer/e	external	event co	ounter/P	WM ou	itput/squa	are-wa	ve outp		
	8-bit timer (TM8)	Number of channels	-		-				-						-								-					-			_	-				-		
		Function	-		-				-			-							-						-			-	-				-					
	Watchdog tim	ner (WDT)	1		1				1		1								1					1		1			1			1						
	Watch timer		-		-				-						-				-						1		1			1			1					
	Real-time cou		-		1				1			1							1						-					-			-					
ace	UART (suppor	rting LIN)	1 (not supporting LIN)		2 ^{*3}				1						1								1					1		1			1			1		
	UART/CSI		-		-				1			1							1						1		1			1			1					
	CSI		- 1		-				-						-								-					-			-	-			-	1		
	Automatic transmit	t/receive 3-wire CSI	-		-				-						-								1					-		,	_	-	4			-		
		ovimation (10 kil)	4 8		-	6			-	6					-		0						- 8			0		1		1			1			1		
verter	Successive appro $\Delta\Sigma$ (16-bit)	oximation (10-bit)		-		0		-		0		_			0		8			_			8			8		5		0			-			0		
rrupt	External		5 8		5				5			_			6		3						7			3		6	7		7	7	-	7	7	- 7		
	Internal		14 20	17	5	18		19	5	20		19			20		21			20			21			22		16	16		, 18	15		17	7 16	19		
imum n	umber of segme	ents & commons	- 20	17	144	10		15	160	20		224			20		160			288			288			224		-	10		10	15		11	10	13		
layed in	LCD	4 commons	_		88				96			128			128		96			160			160			128		80		- 104			- 144			_ 160		
hip deb	bug (MINICUBE		Supported		00				00			120		Suppo			00			100			100			120			ported*6	-	Supported*6		-	Supported*6		_		
			16-bit × 16-bit 32-bit ÷ 16-bit	16-bit × 16-bit – – –							-						-	-		× 16-bit, ÷ 16-bit	-		t × 16-bit, t ÷ 16-bit		16 bit × 32 bit ÷													
iplier/di			4.3 V ±0.2 V							1.93/2.08		39/2.55/2.7 detected v								default)	±0.1 V,								3/2.24/2.39 ±0.1 V, The									
voltage	e detector (LVI)																																					
voltage	e detector (LVI) lear (POC)		3.5 V ±0.2 V	Manchester coo								code gener		1.59 V ±													ock output				1.5	59 V ±0.1	15 V					

*2. TM0 and TM5 can be connected in cascade and used as a 24-bit event counter.
*3. Supports LIN for 1 channel only
*4. Timer for 10-bit inverter control, real-time output port, Hi-Z output controller

Remark The specifications of products still under development or in planning are subject to change without notice.

*6. Only supported in the μ PD78F0363D, 78F0376D, 78F0386D, 78F0397D

Pamphlet U17380EJ9V0PF

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Wave Technology Co., Ltd. http://www.y1000.com/index_e.html

TOKYO ELETECH CORPORATION http://www.tetc.co.jp/e_tet.htm

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Interface Co., Ltd. http://www.itf.co.jp

Sunhayato Corporation http://www.sunhayato.co.jp

TAKUMI SHOJI CO., LTD http://www.takumic.co.jp

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